

# Schottky

High Performance Schottky Diode  
Low Loss and Soft Recovery  
Common Cathode

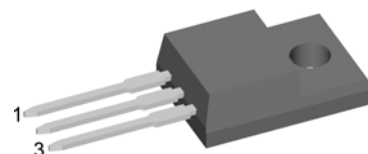
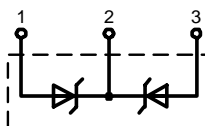
$$V_{RRM} = 60 \text{ V}$$

$$I_{FAV} = 2 \times 10 \text{ A}$$

$$V_F = 0.68 \text{ V}$$

Part number (Marking on product)

DSA 20 C 60PN



## Features / Advantages:

- Very low  $V_f$
- Extremely low switching losses
- Low  $I_{rm}$ -values
- Improved thermal behaviour
- High reliability circuit operation
- Low voltage peaks for reduced protection circuits
- Low noise switching
- Low losses

## Applications:

- Rectifiers in switch mode power supplies (SMPS)
- Free wheeling diode in low voltage converters

## Package:

TO-220FPAB

- Industry standard outline
- Plastic overmolded tab for electrical isolation
- Epoxy meets UL 94V-0
- RoHS compliant

## Ratings

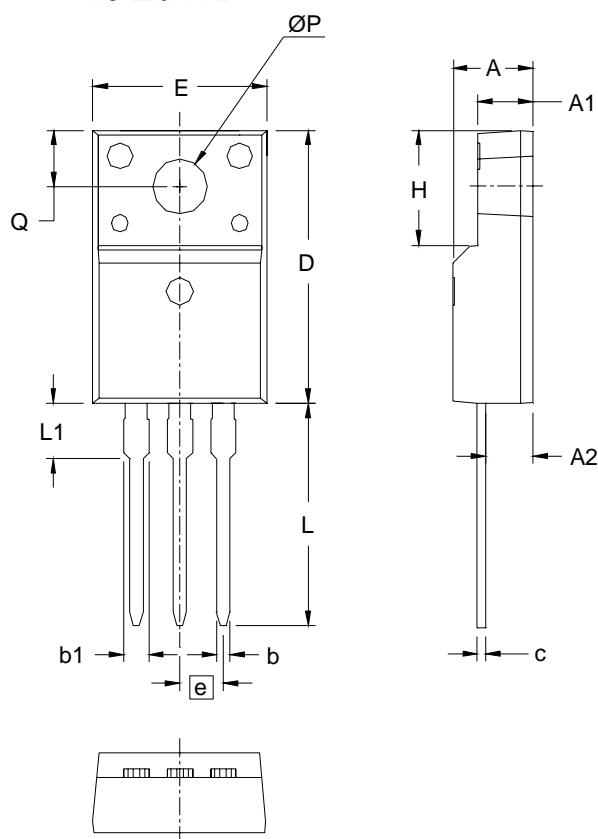
Symbol	Definition	Conditions	min.	typ.	max.	Unit
$V_{RRM}$	max. repetitive reverse voltage	$T_{VJ} = 25 \text{ }^{\circ}\text{C}$			60	V
$I_R$	reverse current	$V_R = 60 \text{ V}$ $T_{VJ} = 25 \text{ }^{\circ}\text{C}$			0.3	mA
		$V_R = 60 \text{ V}$ $T_{VJ} = 125 \text{ }^{\circ}\text{C}$			3	mA
$V_F$	forward voltage	$I_F = 10 \text{ A}$ $T_{VJ} = 25 \text{ }^{\circ}\text{C}$			0.85	V
		$I_F = 20 \text{ A}$ $T_{VJ} = 25 \text{ }^{\circ}\text{C}$			0.95	V
		$I_F = 10 \text{ A}$ $T_{VJ} = 125 \text{ }^{\circ}\text{C}$			0.68	V
		$I_F = 20 \text{ A}$ $T_{VJ} = 125 \text{ }^{\circ}\text{C}$			0.78	V
$I_{FAV}$	average forward current	rectangular, $d = 0.5$ $T_C = 140 \text{ }^{\circ}\text{C}$			10	A
$V_{F0}$	threshold voltage	$T_{VJ} = 175 \text{ }^{\circ}\text{C}$ for power loss calculation only			0.44	V
$r_F$	slope resistance				15	m $\Omega$
$R_{thJC}$	thermal resistance junction to case				4.50	K/W
$T_{VJ}$	virtual junction temperature		-55		175	$^{\circ}\text{C}$
$P_{tot}$	total power dissipation	$T_C = 25 \text{ }^{\circ}\text{C}$			35	W
$I_{FSM}$	max. forward surge current	$t_p = 10 \text{ ms (50 Hz), sine}$ $T_{VJ} = 45 \text{ }^{\circ}\text{C}$			100	A
$C_J$	junction capacitance	$V_R = \text{V}; f = 1 \text{ MHz}$ $T_{VJ} = 25 \text{ }^{\circ}\text{C}$				pF
$E_{AS}$	non-repetitive avalanche energy	$I_{AS} = \text{A}; L = 100 \text{ } \mu\text{H}$ $T_{VJ} = 25 \text{ }^{\circ}\text{C}$			tbd	mJ
$I_{AR}$	repetitive avalanche current	$V_A = 1.5 \cdot V_R$ typ.; $f = 10 \text{ kHz}$			tbd	A

Symbol	Definition	Conditions	Ratings			Unit
			min.	typ.	max.	
$I_{RMS}$	RMS current	per pin*			35	A
$R_{thCH}$	thermal resistance case to heatsink			0.50		K/W
$M_D$	mounting torque		0.4		0.6	Nm
$F_c$	mounting force with clip		20		60	N
$T_{stg}$	storage temperature		-55		150	°C
Weight				2		g

\*  $I_{rms}$  is typically limited by: 1. pin-to-chip resistance; or by 2. current capability of the chip.

In case of 1, a common cathode/anode configuration and a non-isolated backside, the whole current capability can be used by connecting the backside.

## Outlines TO-220FPAB



SYM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	.177	.193	4.50	4.90
A1	.092	.108	2.34	2.74
A2	.101	.117	2.56	2.96
b	.028	.035	0.70	0.90
b1	.050	.058	1.27	1.47
c	.018	.024	0.45	0.60
D	.617	.633	15.67	16.07
E	.392	.408	9.96	10.36
e	.100 BSC		2.54 BSC	
H	.255	.271	6.48	6.88
L	.499	.523	12.68	13.28
L1	.119	.135	3.03	3.43
ØP	.121	.129	3.08	3.28
Q	.126	.134	3.20	3.40